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Innovations in Gemini Column, Detection Technology and Variable Pressure Technology



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Field emission scanning electron microscopy is standard technology for high resolution imaging and different contrasting methods aiming for a comprehensive characterization of specimens. A wide range of applications is covered by classical FE-SEM technology, including imaging surface sensitive and non-conductive samples without pre-treatment. The novel optical design of the Gemini column now delivers high contrast images at low voltage combined with excellent signal detection efficiency and signal-to-noise. Furthermore, an innovated concept for imaging at higher pressure ranges allows fast acquisition of crisp images in variable pressure mode with all the Inlens detectors known from high vacuum mode.

Overview of Gemini electron optics

In 1993 [1] the DSM 982, the first field emission SEM with Gemini technology, was launched. The resolution was 3–4 nm at 1 kV. This was a benchmark for low voltage SEM (LVSEM) and expanded the field of FE-SEM applications into low landing energies. Its major advantages are: reduced sample damage, increased SE yield and higher surface sensitivity for higher resolution thanks to smaller interaction volumes and a small beam. The Gemini optical concept incorporates the Gemini objective lens and the beam booster. The Gemini lens is a compound magnetic-electrostatic objective lens (Fig. 1). With this type of lens, the chromatic

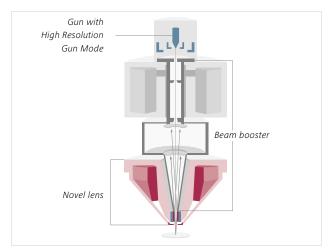


Figure 1 Schematic cross-section of Gemini optical column with new high resolution gun mode, beam booster, Inlens detectors, novel lens design (compound lens consisting of magnetic and electrostatic lens).

and spherical imaging aberrations (Cc and Cs) decrease significantly with decreasing beam energy [2]. The novel optical design of the Gemini column mainly lies in innovations in gun mode and lens design. By further optimizing geometry and electrostatic, as well as magnetic field distributions, the Gemini objective lens has been optimized even further. It now provides 1.2 nm at 500 V. In addition, no usability issues, such as additional fields at the sample, need to be taken into account, as they

A special gun mode was developed to reduce the energy spread of the primary beam. The effect of the already reduced chromatic aberration is further minimized to allow even smaller probe sizes and keep resolution sufficient even at voltages lower than 1 kV.

would occur with sample biasing.

The electron optical performance is maximized while field influences at the sample are reduced to a minimum. The novel Gemini objective lens delivers excellent imaging conditions even on challenging samples such as magnetic materials. As before, the Gemini beam booster technology (Fig. 1) guarantees small probe sizes and high signal-to-noise ratios down to ultra-low accelerating voltages. System sensitivity to external stray fields is minimized by keeping the beam at high voltage throughout the column until its final deceleration.

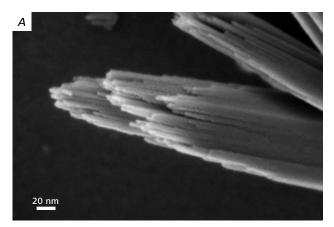


Figure 2 a) Nanometer spaced FeO(OH) crystals at imaged at 1 kV. Sample: courtesy of L. Maniguet, INP Grenoble, FR.

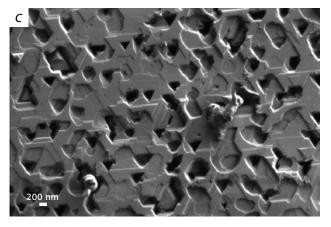


Figure 2 c) Etched silicon nano-structures imaged at 50 V beam voltagewithout sample biasing. Sample: courtesy of A. Charai, Aix Marseille University, *France.*

Gemini technology enables high resolution at low voltage

High resolution at low voltage is needed to avoid beam damage and to balance the SE yield and beam current for charge neutrality. With the two following application examples (Fig. 2 A, B), we were able to easily achieve excellent imaging conditions in charging samples like AI_2O_3 or in beam sensitive and charging materials like FeO(OH). In the AI_2O_3 sample surface, steps of one to several monolayers can be imaged. Goethite (FeO(OH)) has nanometer sized gaps, originating from water molecules leaving the crystal during the dehydration process.

Detection technology – detectors for high resolution, sensitivity and efficiency

The Gemini detection concept assures efficient signal detection by detecting secondary (SE) and backscattered (BSE) electrons in parallel. The Inlens detectors are arranged on the optical axis which reduces the need for realignment

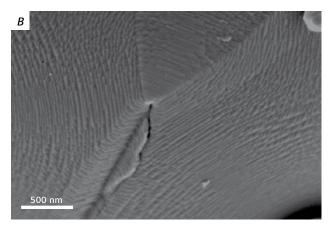


Figure 2 b) Surface of a Al₂O₃ sphere.

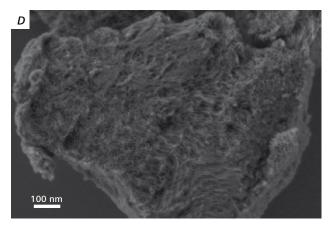


Figure 2 d) Mesoporous Silica imaged at 500 V.

and thus minimizes time to image. The optimization of high resolution properties and detection efficiency provide high guality SEM images. The Gemini objective lens with a novel design optimizes in-lens SE detection as it not only acts as an imaging lens, but also enhances detection for secondary and backscattered electrons emitted by the sample: the electron trajectories for the detection path are further improved by the novel design of the objective lens. Here, the in-lens SE signal is up to 20 times higher compared to classic SEM designs. This enables imaging at very low voltages and usage of fast scan speeds for high speed sample investigation. The great flexibility of usage of different voltages is shown in Fig. 2 C, D. Voltages of 500 V, or even 50 V, can be used to acquire images with a good signal-to-noise ratio. In zeolite channels can be imaged clearly down to sizes of only several nanometers (Fig. 2D). Here the combination of high resolution with good detection efficiency-both at low voltage-is essential and can be achieved without biasing the sample holder.

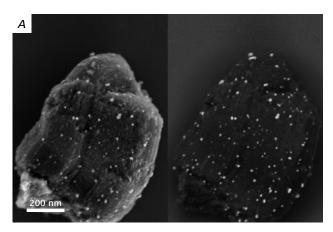


Figure 3 a) Catalyst: Silver nano-particles embedded in Zeolite, SE (left) and EsB (right), at 1.5 kV. Sample: courtesy of G. Weinberg, Fritz-Haber-Institute of the Max-Planck society, Germany.

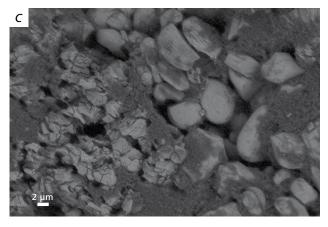


Figure 3 c) Lithium ion battery cathode material, BSE compositional contrast, no damage in sensitive binder material. Sample: courtesy of T. Bernthaler, Materials Research Institute Aalen, Germany.

Moreover, the energy filtering properties of the Gemini lens are also valuable for imaging doping profiles of semiconductor structures with enhanced voltage contrast. It was demonstrated [3] that for the Gemini lens, this contrast can be optimized with specific high tensions and working distances by selecting only certain SE take off angles and energies.

Detection Technology – Inlens EsB detector for energy filtering and detection of low voltage BSE

A second detector on the optical axis in the column is the Inlens EsB (energy selective backscatter) detector with an energy filtering grid that enables a separation of SE and BSE. Energy filtering can be used to enhance material contrast for low loss BSE due to spectral differences [4]. This new trend in SEM of looking into spectroscopic information of the detected electrons is gaining momentum. Nagoshy et al. [5] have recently described a method using the combination of the energy filtered grid bias and the pixel-by-pixel image

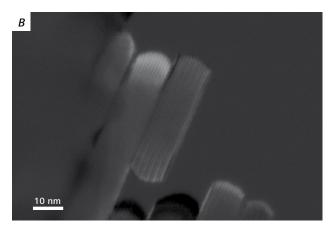


Figure 3 b) BaFe₁₂O₁₉ nano-particles shows 1.1 nm (002) lattice spacing. Sample: courtesy of H. Romanus, TU Ilmenau, Germany.

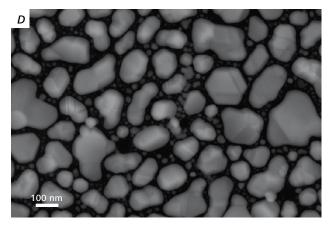


Figure 3 d) Gold on carbon sample, BSE channeling contrast.

subtraction, thus providing the band-pass energy filtered images and extracting the material and topographic information of the specimen.

The EsB detector is an efficient BSE detector, which can be used even at low voltages. Thanks to the smaller interaction volume at low primary energies, nano structures especially can be imaged at high resolution without being blurred by additional matrix signal. At beam voltages of 1.5 kV or lower the excellent sensitivity and resolution of the Inlens EsB detector can be demonstrated. Silver nano particles embedded in the Zeolite just underneath the surface are clearly visible.

Detection Technology – STEM and BSE

In addition to the in-lens detectors, improved semiconductor detectors are available for BSE and STEM (scanning transmission electron microscopy) imaging. Both are available as semiconductor, multi-segment detectors. The common feature of those retractable detectors is: angular sensitivity at fairly low voltages combined with excellent signal-tonoise ratios. The segments can be read out individually, in multiple combinations and up to four signals in parallel. For STEM this enables the most commonly used brightfield (BF), Oriented darkfield (ODF) and High angular annular darkfield (HAADF) modes. For the BSE detector the standard modes are compositional or topographical imaging with the back scattered electrons.

The Bariumhexaferrites are magnetic nano-particles with multiferroic properties. Here we can achieve lattice resolution in the Gemini SEM measured in transmission with the STEM detector (Fig. 3B).

Compositional and channeling BSE contrasts can be obtained by semiconductor multi-segment backscatter detectors. As an example here, for lithium battery research the user can quickly identify binder material next to the lithium cobaltate. The microstructure clearly reveals the degeneration of a lithium battery (Fig. 3C).

For convenient backscatter imaging at higher pressures (see next chapter), this detector is integrated into an aperture. It can be used in low vacuum, with a large range of pressure variations.

Variable Pressure Technology

The new variable pressure (VP) technology permits operation at higher pressures with high resolution and improved signal detection efficiency, allowing a maximum flexibility using all detectors from high vacuum: SE, Inlens SE, Inlens EsB, BSD and VPSE detectors.

VP – Overview

Variable pressure scanning electron microscopy (VPSEM) has gained considerable interest since its commercial introduction more than 30 years ago [6]. The driver here is the possibility of examining insulating materials without modifying the surface by a conductive coating.

In the VPSEM, the inelastic scattering of beam and backscattered electrons with gas atoms create free electrons and positive ions. These charged species are attracted to the charged areas on the sample surface and discharge them. This gas ionization process is further augmented by secondary electrons and backscattered electrons emitted from the

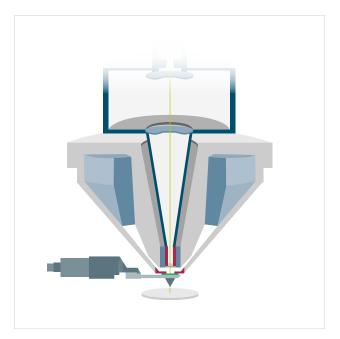


Figure 4 Pressure-limiting aperture integrated with a 5-segment BSD detector

specimen. These electrons are subsequently accelerated by the applied potential of the pressure-limiting aperture (PLA) and VPSE detector. A cascade of ionization and secondary electron multiplication creates a much higher density of charge carriers in the SEM. Stable images of bare insulators, such as metal coatings or particles on glass, can be observed at high resolution in this new VP mode.

However, as a result of the skirt effect of the primary electron beam – a broadening of the beam due to interactions with the charged particles in the chamber [6]-, resolution of VPSEM is usually significantly reduced compared to normal SEM. VPSEM is also particularly difficult for EDS application, where additional X-rays are generated from the electron skirt and thus disturb accurate EDS analyses. The newly developed VP implementation reduces the skirt effect in high gas pressure dramatically and also enables detection of the pure secondary electron (SE) signal using Inlens detectors.

VP – Technical Description

In a variable pressure experiment, pressure, gas path length and primary energy can all be adjusted. Equation (1) describes the impact of various parameters on elastic scattering by the gas atoms. $r^{s} = (364Z/E) (p/T)^{1/2} L^{3/2}$

(1)

Thus, the size of the skirt (r_s) can be reduced by:

- increasing the beam energy
- reducing the pressure p of the environmental gas to the minimum required for a stable, charged-compensated sample
- decreasing the gas path length L.

Comparing the influences of the various terms in equation (1), we can see that modifying the gas path length will have one of the strongest influences on the skirt. For the new VP concept, the design is consequentially following this dependency. The pressure-limiting aperture helps to keep gas path length (L) short, whereby its height is optimized so that L is below 3 mm at analytical working distance, which significantly reduces the skirt effect. Furthermore the detector can detect the true SE signal, which carries only the surface information. The implementation of the novel VP technology does not influence the electron optic system during VP operation, thus high resolution is obtained even in VP. The same beam spot size is achieved compared to that in high vacuum mode.

The pressure-limiting aperture

The essential component of the VP implementation is a retractable pressure-limiting aperture illustrated in Figure 5. When in place, it permits up to 500 Pa pressure in the specimen chamber, while the pressure in the objective lens is maintained in high vacuum. The beam booster (Fig. 1) can be used during VP operation, so that high resolution can be achieved at low beam energy. Moreover, Inlens SE and EsB detectors can now detect SE and BSE electrons in VP mode thanks to the beam booster, which significantly improves the SNR (signal-to-noise) of the signal. To facilitate detection of SE on a detector, voltages up to 500 V can be applied to the pressure-limiting aperture, which attracts signal electrons into the aperture and further into the objective lens. The high angle BSE signal is collected with a 5-segment diode detector that can be integrated into the pressure-limiting aperture.

Vacuum Modes in VP

Introducing the novel VP implementation and objective lens design enables a high flexibility for advanced imaging, at high and low pressures. Table 2 illustrates the great flexibility of the new VP system. Given the conductivity of the sample and required electron dosage for high or low resolution imaging, multiple modes of VP operation can be realized to optimize imaging conditions. Variable pressure mode, nano variable pressure mode and extended variable pressure mode are distinguished by different aperture sizes, beam booster modi and pressure ranges.

Mode	pressure-limiting aperture	Booster	Chamber Pressure (Pa)
High Vacuum HV	None	On	< 10-2
Variable Pressure VP	None	Off	5 – 30
Nano VP	800 μm 350 μm	On On	5 – 40 5 – 150
XVP	800 μm 350 μm	Off Off	5 – 150 150 – 500

Tab. 2: Vacuum modes for the new VP concept

Detectors in VP: VPSE, Inlens SE, EsB, VPBSD

With the pressure-limiting aperture in operation, the available detectors are VPSE, Inlens SE, Inlens EsB and VPBSD for pressures up to 150 Pa. For higher pressures (up to 500 Pa) the booster can be switched off and in the XVP mode, the signal can be detected with the VPSE or VPBSD detector. Fig. 4 shows the improvement of the new VPSE compared to conventional VPSE technology.

VP and sample flexibility

The advantage of the new VPSE detector is demonstrated on a polymer sample where good resolution, combined with excellent signal-to-noise, is clearly visible (Fig. 5A). Natural fibers coated with silver nano-particles can be imaged at 80 Pa and 10 kV in relative low magnification (Fig. 5B). Both Inlens SE and EsB detectors are used to obtain surface topography and material contrast, and these two kinds of contrast are clearly separated. On filter paper, imaged at 80 Pa and 3 kV in a medium-range magnification, charging effects are completely eliminated and again excellent SNR is obtained (Fig. 5C).

A very high magnification image is obtained on gold/palladium (Au/Pd) thin film deposited on glass. Although the Au/Pd thin film is conductive, the film is not grounded but floating on an insulator. Imaging this sample in high vacuum will cause charge buildup and constant shifting of focus. With the novel VP mode the fine grain structure, smaller than 10 nm, can be clearly resolved (Fig. 5D).

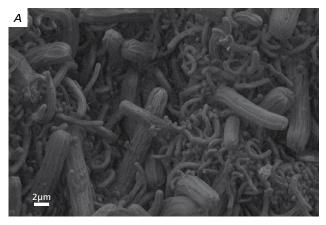


Figure 5 a) Fibrous polymer microstructures imaged at 150 Pa and 3 kV, VPSE detector. Sample: courtesy of Dr. H.-G. Braun, Leibniz Institute of Polymer Research Dresden, Germany.

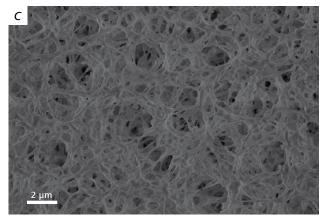


Figure 5 c) Image shows medium magnification of filter paper, imaged at 80 Pa and 3 kV Inlens SE.

Conclusion

Based on more than 20 years of experience with Gemini technology, these systems offer complete and efficient detection, excellent resolution and leading ease of use. With the latest Gemini lens design, the resolution limits are pushed to lower voltages again, resulting in sufficient resolu-

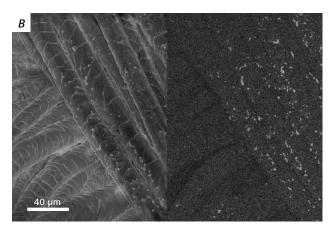


Figure 5 b) Low magnification Ag nano-particle coated natural fibers, imaged with Inlens SE (left) and EsB (right) detectors at 80 Pa and 10 kV, Sample: courtesy of SBUK and Dr. F. Simon, Leibniz Institute of Polymer Research Dresden, Germany,

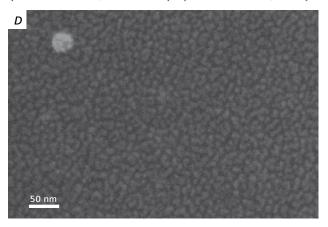


Figure 5 d) High magnification of Au/Pd thin film deposited on glass, imaged at 40 Pa and 5 kV, Inlens SE.

tion over a large voltage range (30 kV down to several 10 V), high flexibility is achieved for the electron microscopist thanks to retractable detectors and retractable pressure limiting aperture for the VP mode. It is designed for advanced imaging at high and low pressures and matching real world sample requirements.

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